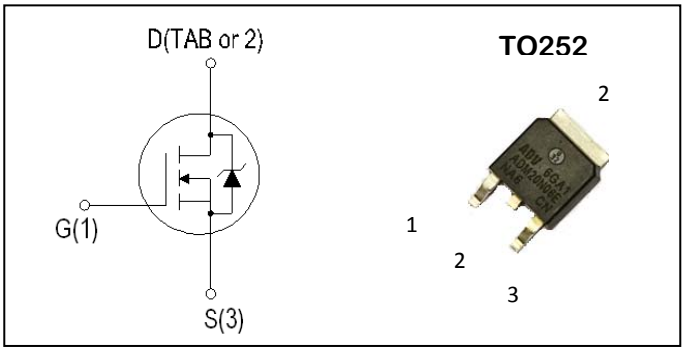
N-Channel Enhancement Mode Field Effect Transistor



PRODUCT SUMMARY

V_{DSS}	I_D	$R_{DS(ON)}$ (mΩ)
100V	10A	135mΩ

Absolute Maximum Ratings (T_A = 25°C unless otherwise specifed)

Symbol	Parameter		Ratings	Unit
Common Ratings				
V_{DSS}	Drain-Source Voltage		100	V
V_{GSS}	Gate-Source Voltage		±20	
T_J	Maximum Junction Temperature		150	°C
T_{STG}	Storage Temperature Range		-55 to 150	°C
I_S	Diode Continuous Forward Current	TC=25°C	10	A
Mounted on Large Heat Sink				
I_{DM}	300μs Pulse Drain Current Tested(1)	T_C=25°C	40	A
I_D	Continuous Drain Current	T_C=25°C	10	A
		T_C=70°C	7	A
P_D	Maximum Power Dissipation	T_C=25°C	3.0	W

1. Pulse width limited by maximum junction temperature.

Thermal Characteristics

Symbol	Parameter	Ratings	Unit
R_{thJC}	Thermal resistance junction-case max	2.5	°C/W
R_{thJA}	Thermal resistance junction-ambient max	41.7	°C/W

Electrical Characteristics (TA=25°C Unless Otherwise Noted)

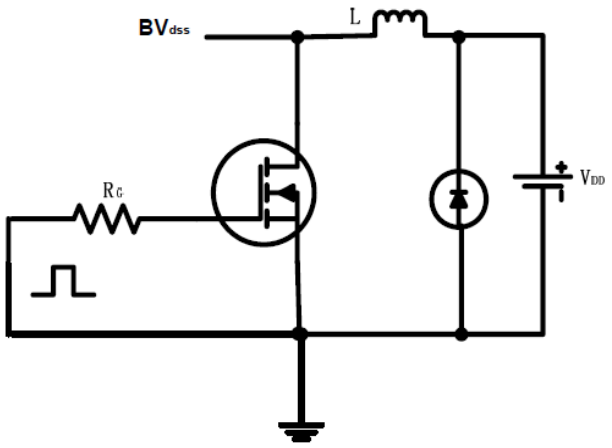
Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit
On/off Characteristics						
BV_{DSS}	Drain-Source Breakdown Voltage	V_{GS}=0V, I_{DS}=250uA	100	--	--	V
I_{DSS}	Zero Gate Voltage Drain Current	V_{DS}= 80V, V_{GS}=0V	--	--	1	uA
		V_{DS}=80V, V_{GS}=0V T_J=55°C	--	--	10	
$V_{GS(th)}$	Gate Threshold Voltage	V_{DS}=V_{GS}, I_{DS}=250uA	1	1.7	3.0	V
I_{GSS}	Gate Leakage Current	V_{GS}=±20V, V_{DS}=0V	--	--	±100	nA
$R_{DS(ON)}$	Drain-SourceOn-stateResistance(2)	V_{GS}= 10V, I_{DS}=2A	--	112	135	mΩ
g_{FS}	Forward transconductance(2)	V_{DS}= 5V, I_{DS}=2A	--	8	--	S
Dynamic Characteristics						
C_{iss}	Input Capacitance	V_{GS}=0V,	--	610	--	pF
C_{oss}	Output Capacitance	V_{DS}= 25V,	--	40	--	
C_{rss}	Reverse Transfer Capacitance	Frequency=1.0MHz	--	25	--	
Switching Characteristics						
$t_{d(ON)}$	Turn-on Delay Time(1)	V_{DD}=50V,	--	7	--	ns
t_r	Turn-on Rise Time(1)	I_D= 1A, V_{GS}= 10V,	--	5	--	
$t_{d(OFF)}$	Turn-off Delay Time(1)	R_{GEN}=3.3Ω	--	16	--	
t_f	Turn-off Fall Time(1)		--	6	--	
Q_g	Total Gate Charge(1)	V_{DS}=8V, V_{GS}= 10V,	--	12	--	nC
Q_{gs}	Gate-Source Charge(1)	I_{DS}=2A	--	2.2	--	
Q_{gd}	Gate-Drain Charge(1)		--	2.5	--	
Diode Characteristics						
V_{SD}	Diode Forward Voltage(2)	I_{SD} = 1.2A, V_{GS} = 0	--	--	1.2	V
t_{rr}	Reverse Recovery Time	I_{SD}=2A, dI/dt=100A/μs	--	21	--	ns
q_{rr}	Reverse Recovery Charge		--	21	--	nC

NOTES:

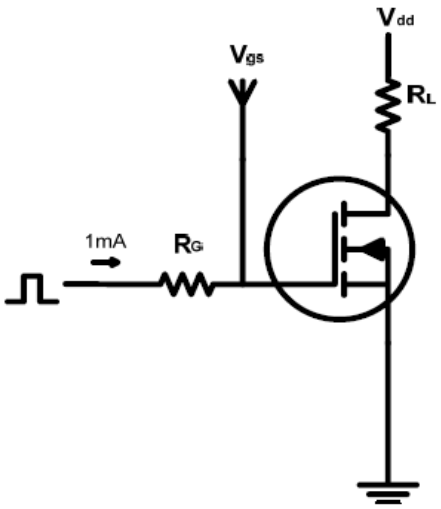
1. Independent of operating temperature.
2. Pulse Test : Pulse width ≤ 300μs, Duty cycle ≤ 2%

Test circuits and Waveforms

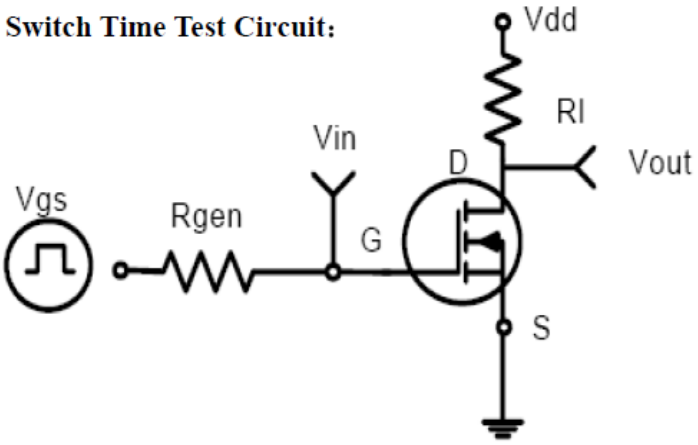
EAS test circuits:



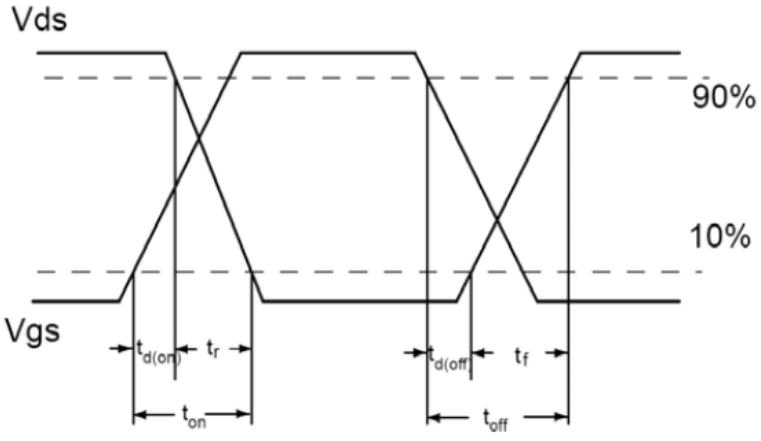
Gate charge test circuit:



Switch Time Test Circuit:

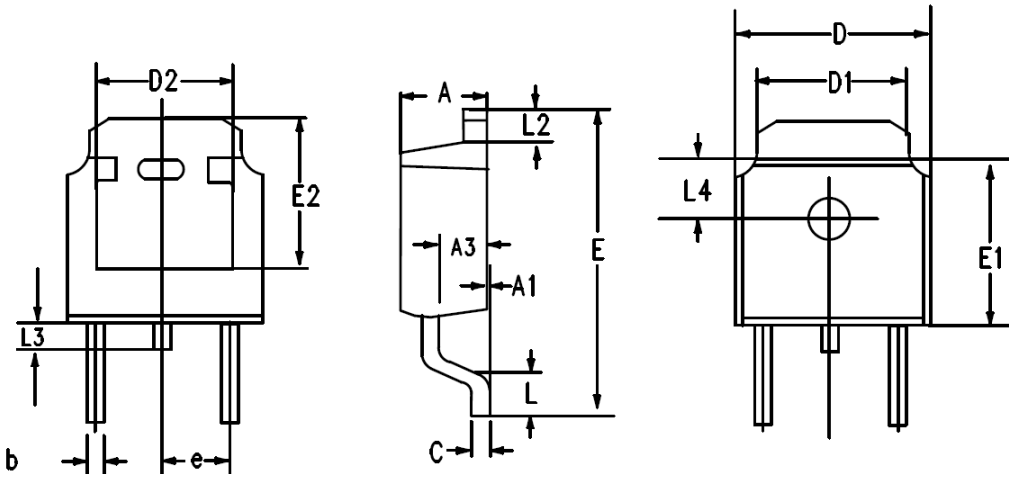


Switch Waveforms:



PACKAGE MECHANICAL DATA

TO-252 Package Dimension



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min.	Max.	Min.	Max.
A	2.200	2.400	0.087	0.094
A1	0.000	0.127	0.000	0.005
A3	1.020	1.120	0.040	0.044
b	0.740	0.820	0.029	0.032
c	0.510	0.580	0.020	0.023
D	6.500	6.700	0.256	0.263
D1	5.200	5.400	0.205	0.213
D2	4.830REF.		0.190REF.	
E	9.900	10.300	0.390	0.405
E1	6.000	6.200	0.236	0.244
E2	5.300 REF.		0.208 REF.	
e	2.286TYP.		0.090 TYP.	
L	1.400	1.600	0.055	0.063
L2	0.900	1.250	0.035	0.049
L3	0.600	1.000	0.024	0.039
L4	1.700	1.900	0.066	0.075